

# Single Non-Inverting Buffer with Open Drain Output

## NL17SZ07

The NL17SZ07 is a single non-inverting buffer with open drain outputs in tiny footprint packages.

### Features

- Designed for 1.65 V to 5.5 V  $V_{CC}$  Operation
- 2.1 ns  $t_{PD}$  at  $V_{CC} = 5$  V (typ)
- Input/Output Overvoltage Tolerant up to 5.5 V
- $I_{OFF}$  Supports Partial Power Down Protection
- Sink 24 mA at 3.0 V
- Available in SC-88A, SC-74A, SOT-553, SOT-953 and UDFN6 Packages
- Chip Complexity < 100 FETs
- Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

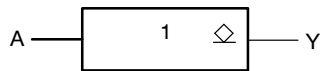
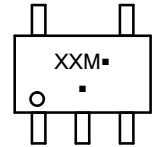


Figure 1. Logic Symbol

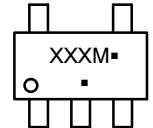
### MARKING DIAGRAMS



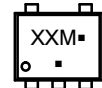
SC-88A  
DF SUFFIX  
CASE 419A



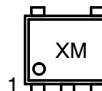
SC-74A  
DBV SUFFIX  
CASE 318BQ



SOT-553  
XV5 SUFFIX  
CASE 463B



SOT-953  
P5 SUFFIX  
CASE 527AE



UDFN6  
1.0 x 1.0  
CASE 517BX



XX = Specific Device Code  
M = Date Code\*  
▪ = Pb-Free Package

(Note: Microdot may be in either location)

\* Date Code orientation and/or position may vary depending upon manufacturing location.

### ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 7 of this data sheet.

# NL17SZ07

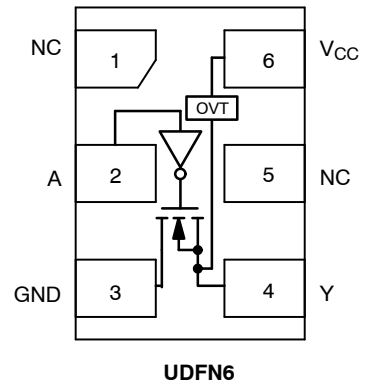
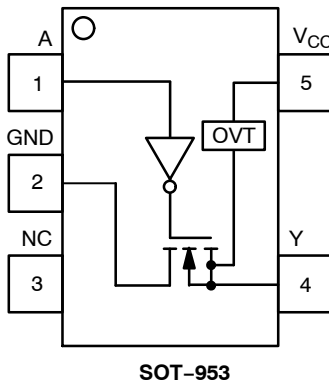
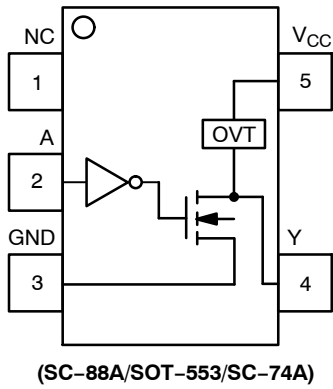


Figure 2. Pinout (Top View)

## PIN ASSIGNMENT

(SC-88A/SOT-553/SC-74A)

| Pin | Function        |
|-----|-----------------|
| 1   | NC              |
| 2   | A               |
| 3   | GND             |
| 4   | Y               |
| 5   | V <sub>CC</sub> |

## PIN ASSIGNMENT (SOT-953)

| Pin | Function        |
|-----|-----------------|
| 1   | A               |
| 2   | GND             |
| 3   | NC              |
| 4   | Y               |
| 5   | V <sub>CC</sub> |

## PIN ASSIGNMENT (UDFN)

| Pin | Function        |
|-----|-----------------|
| 1   | NC              |
| 2   | A               |
| 3   | GND             |
| 4   | Y               |
| 5   | NC              |
| 6   | V <sub>CC</sub> |

## FUNCTION TABLE

| Input | Output |
|-------|--------|
| A     | Y      |
| L     | L      |
| H     | Z      |

MAXIMUM RATINGS

| Symbol                | Characteristics                                                                                                      | Value                                                  | Unit |
|-----------------------|----------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------|------|
| $V_{CC}$              | DC Supply Voltage                                                                                                    | -0.5 to +6.5                                           | V    |
| $V_{IN}$              | DC Input Voltage                                                                                                     | -0.5 to +6.5                                           | V    |
| $V_{OUT}$             | DC Output Voltage<br>Active-Mode (High or Low State)<br>Tri-State Mode (Note 1)<br>Power-Down Mode ( $V_{CC} = 0$ V) | -0.5 to $V_{CC} + 0.5$<br>-0.5 to +6.5<br>-0.5 to +6.5 | V    |
| $I_{IK}$              | DC Input Diode Current<br>$V_{IN} < GND$                                                                             | -50                                                    | mA   |
| $I_{OK}$              | DC Output Diode Current<br>$V_{OUT} < GND$                                                                           | -50                                                    | mA   |
| $I_{OUT}$             | DC Output Source/Sink Current                                                                                        | $\pm 50$                                               | mA   |
| $I_{CC}$ or $I_{GND}$ | DC Supply Current per Supply Pin or Ground Pin                                                                       | $\pm 100$                                              | mA   |
| $T_{STG}$             | Storage Temperature Range                                                                                            | -65 to +150                                            | °C   |
| $T_L$                 | Lead Temperature, 1 mm from Case for 10 secs                                                                         | 260                                                    | °C   |
| $T_J$                 | Junction Temperature Under Bias                                                                                      | +150                                                   | °C   |
| $\theta_{JA}$         | Thermal Resistance (Note 2)<br>SC-88A<br>SC-74A<br>SOT-553<br>SOT-953<br>UDFN6                                       | 377<br>320<br>324<br>254<br>154                        | °C/W |
| $P_D$                 | Power Dissipation in Still Air<br>SC-88A<br>SC-74A<br>SOT-553<br>SOT-953<br>UDFN6                                    | 332<br>390<br>386<br>491<br>812                        | mW   |
| MSL                   | Moisture Sensitivity                                                                                                 | Level 1                                                | -    |
| $F_R$                 | Flammability Rating<br>Oxygen Index: 28 to 34                                                                        | UL 94 V-0 @ 0.125 in                                   | -    |
| $V_{ESD}$             | ESD Withstand Voltage (Note 3)<br>Human Body Model<br>Charged Device Model                                           | 2000<br>1000                                           | V    |
| $I_{Latchup}$         | Latchup Performance (Note 4)                                                                                         | $\pm 100$                                              | mA   |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Applicable to devices with outputs that may be tri-stated.
2. Measured with minimum pad spacing on an FR4 board, using 10mm-by-1inch, 2 ounce copper trace no air flow per JESD51-7.
3. HBM tested to ANSI/ESDA/JEDEC JS-001-2017. CDM tested to EIA/JESD22-C101-F. JEDEC recommends that ESD qualification to EIA/JESD22-A115-A (Machine Model) be discontinued per JEDEC/JEP172A.
4. Tested to EIA/JESD78 Class II.



# RECOMMENDED OPERATING CONDITIONS

| Symbol     | Characteristics                                                                                                                                        | Min              | Max                    | Unit |
|------------|--------------------------------------------------------------------------------------------------------------------------------------------------------|------------------|------------------------|------|
| $V_{CC}$   | Positive DC Supply Voltage                                                                                                                             | 1.65             | 5.5                    | V    |
| $V_{IN}$   | DC Input Voltage                                                                                                                                       | 0                | 5.5                    | V    |
| $V_{OUT}$  | DC Output Voltage<br>Active-Mode (High or Low State)<br>Tri-State Mode (Note 1)<br>Power-Down Mode ( $V_{CC} = 0$ V)                                   | 0<br>0<br>0      | $V_{CC}$<br>5.5<br>5.5 | V    |
| $T_A$      | Operating Temperature Range                                                                                                                            | -55              | +125                   | °C   |
| $t_r, t_f$ | Input Rise and Fall Time<br>$V_{CC} = 1.65$ V to $1.95$ V<br>$V_{CC} = 2.3$ V to $2.7$ V<br>$V_{CC} = 3.0$ V to $3.6$ V<br>$V_{CC} = 4.5$ V to $5.5$ V | 0<br>0<br>0<br>0 | 20<br>20<br>10<br>5    | ns/V |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

# DC ELECTRICAL CHARACTERISTICS

| Symbol    | Parameter                      | Condition                                                                                                                                                                                                                         | $V_{CC}$<br>(V)                                        | $T_A = 25^\circ\text{C}$        |                                                  |                                                  | $-55^\circ\text{C} \leq T_A \leq 125^\circ\text{C}$ |                                                  | Units         |
|-----------|--------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------|---------------------------------|--------------------------------------------------|--------------------------------------------------|-----------------------------------------------------|--------------------------------------------------|---------------|
|           |                                |                                                                                                                                                                                                                                   |                                                        | Min                             | Typ                                              | Max                                              | Min                                                 | Max                                              |               |
| $V_{IH}$  | High-Level Input Voltage       |                                                                                                                                                                                                                                   | 1.65 to 1.95                                           | $0.65 \times V_{CC}$            | –                                                | –                                                | $0.65 \times V_{CC}$                                | –                                                | V             |
|           |                                |                                                                                                                                                                                                                                   | 2.3 to 5.5                                             | $0.70 \times V_{CC}$            | –                                                | –                                                | $0.70 \times V_{CC}$                                | –                                                |               |
| $V_{IL}$  | Low-Level Input Voltage        |                                                                                                                                                                                                                                   | 1.65 to 1.95                                           | –                               | –                                                | $0.35 \times V_{CC}$                             | –                                                   | $0.35 \times V_{CC}$                             | V             |
|           |                                |                                                                                                                                                                                                                                   | 2.3 to 5.5                                             | –                               | –                                                | $0.30 \times V_{CC}$                             | –                                                   | $0.30 \times V_{CC}$                             |               |
| $V_{OL}$  | Low-Level Output Voltage       | $V_{IN} = V_{IH}$ or $V_{IL}$<br>$I_{OL} = 100 \mu\text{A}$<br>$I_{OL} = 4 \text{ mA}$<br>$I_{OL} = 8 \text{ mA}$<br>$I_{OL} = 12 \text{ mA}$<br>$I_{OL} = 16 \text{ mA}$<br>$I_{OL} = 24 \text{ mA}$<br>$I_{OL} = 32 \text{ mA}$ | 1.65 to 5.5<br>1.65<br>2.3<br>2.7<br>3.0<br>3.0<br>4.5 | –<br>–<br>–<br>–<br>–<br>–<br>– | –<br>0.08<br>0.2<br>0.22<br>0.28<br>0.38<br>0.42 | 0.1<br>0.24<br>0.3<br>0.4<br>0.4<br>0.55<br>0.55 | –<br>–<br>–<br>–<br>–<br>–<br>–                     | 0.1<br>0.24<br>0.3<br>0.4<br>0.4<br>0.55<br>0.55 | V             |
| $I_{IN}$  | Input Leakage Current          | $V_{IN} = 5.5$ V or GND                                                                                                                                                                                                           | 1.65 to 5.5                                            | –                               | –                                                | $\pm 0.1$                                        | –                                                   | $\pm 1.0$                                        | $\mu\text{A}$ |
| $I_{OZ}$  | 3-State Output Leakage Current | $V_{OUT} = 0$ V to $5.5$ V                                                                                                                                                                                                        | 1.65 to 5.5                                            | –                               | –                                                | $\pm 0.5$                                        | –                                                   | $\pm 5.0$                                        | $\mu\text{A}$ |
| $I_{OFF}$ | Power Off Leakage Current      | $V_{IN} = 5.5$ V or $V_{OUT} = 5.5$ V                                                                                                                                                                                             | 0                                                      | –                               | –                                                | 1.0                                              | –                                                   | 10                                               | $\mu\text{A}$ |
| $I_{CC}$  | Quiescent Supply Current       | $V_{IN} = V_{CC}$ or GND                                                                                                                                                                                                          | 5.5                                                    | –                               | –                                                | 1.0                                              | –                                                   | 10                                               | $\mu\text{A}$ |
| $I_{CCT}$ | Quiescent Supply Current       | $V_{IN} = 3.0$ V                                                                                                                                                                                                                  | 3.6                                                    | –                               | –                                                | 10                                               | –                                                   | 100                                              | $\mu\text{A}$ |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

### AC ELECTRICAL CHARACTERISTICS

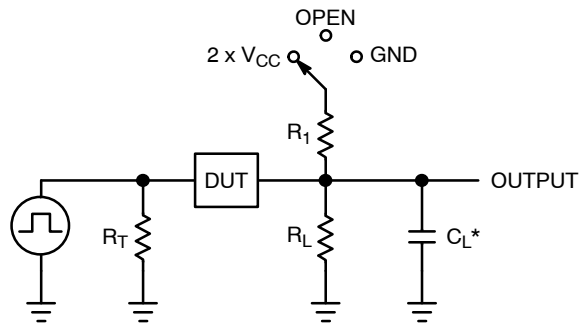
| Symbol           | Parameter                                      | Condition | V <sub>CC</sub><br>(V) | T <sub>A</sub> = 25°C |     |     | -55°C ≤ T <sub>A</sub> ≤ 125°C |     | Units |
|------------------|------------------------------------------------|-----------|------------------------|-----------------------|-----|-----|--------------------------------|-----|-------|
|                  |                                                |           |                        | Min                   | Typ | Max | Min                            | Max |       |
| t <sub>PZL</sub> | Propagation Delay, A to Y<br>(Figures 3 and 4) |           | 1.65 to 1.95           | –                     | 6.0 | 9.0 | –                              | 9.5 | ns    |
|                  |                                                |           | 2.3 to 2.7             | –                     | 3.6 | 6.1 | –                              | 6.5 |       |
|                  |                                                |           | 3.0 to 3.6             | –                     | 2.7 | 5.6 | –                              | 6.0 |       |
|                  |                                                |           | 4.5 to 5.5             | –                     | 2.1 | 4.4 | –                              | 4.8 |       |
| t <sub>PLZ</sub> | Propagation Delay, A to Y<br>(Figures 3 and 4) |           | 1.65 to 1.95           | –                     | 4.0 | 9.0 | –                              | 9.5 | ns    |
|                  |                                                |           | 2.3 to 2.7             | –                     | 2.8 | 6.1 | –                              | 6.5 |       |
|                  |                                                |           | 3.0 to 3.6             | –                     | 2.5 | 5.6 | –                              | 6.0 |       |
|                  |                                                |           | 4.5 to 5.5             | –                     | 2.2 | 4.4 | –                              | 4.8 |       |

### CAPACITIVE CHARACTERISTICS

| Symbol           | Parameter                                 | Condition                                                                 | Typical | Units |
|------------------|-------------------------------------------|---------------------------------------------------------------------------|---------|-------|
| C <sub>IN</sub>  | Input Capacitance                         | V <sub>CC</sub> = 5.5 V, V <sub>IN</sub> = 0 V or V <sub>CC</sub>         | 2.5     | pF    |
| C <sub>OUT</sub> | Output Capacitance                        | V <sub>CC</sub> = 5.5 V, V <sub>IN</sub> = 0 V or V <sub>CC</sub>         | 4.0     | pF    |
| C <sub>PD</sub>  | Power Dissipation Capacitance<br>(Note 5) | 10 MHz, V <sub>CC</sub> = 5.5 V, V <sub>IN</sub> = 0 V or V <sub>CC</sub> | 4.0     | pF    |

5. C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: I<sub>CC(OPR)</sub> = C<sub>PD</sub> • V<sub>CC</sub> • f<sub>in</sub> + I<sub>CC</sub>. C<sub>PD</sub> is used to determine the no-load dynamic power consumption; P<sub>D</sub> = C<sub>PD</sub> • V<sub>CC</sub><sup>2</sup> • f<sub>in</sub> + I<sub>CC</sub> • V<sub>CC</sub>.





$C_L$  includes probe and jig capacitance  
 $R_T$  is  $Z_{OUT}$  of pulse generator (typically 50  $\Omega$ )  
 $f = 1$  MHz

Figure 3. Test Circuit

| Test                | Switch Position   | $C_L$ , pF                   | $R_L$ , $\Omega$ | $R_1$ , $\Omega$ |
|---------------------|-------------------|------------------------------|------------------|------------------|
| $t_{PLH} / t_{PHL}$ | Open              | See AC Characteristics Table |                  |                  |
| $t_{PLZ} / t_{PZL}$ | $2 \times V_{CC}$ | 50                           | 500              | 500              |
| $t_{PHZ} / t_{PZH}$ | GND               | 50                           | 500              | 500              |

X = Don't Care



Figure 4. Switching Waveforms

| $V_{CC}$ , V | $V_{mi}$ , V | $V_{mo}$ , V          |                                               | $V_Y$ , V |
|--------------|--------------|-----------------------|-----------------------------------------------|-----------|
|              |              | $t_{PLH}$ , $t_{PHL}$ | $t_{PZL}$ , $t_{PLZ}$ , $t_{PZH}$ , $t_{PHZ}$ |           |
| 1.65 to 1.95 | $V_{CC}/2$   | $V_{CC}/2$            | $V_{CC}/2$                                    | 0.15      |
| 2.3 to 2.7   | $V_{CC}/2$   | $V_{CC}/2$            | $V_{CC}/2$                                    | 0.15      |
| 3.0 to 3.6   | $V_{CC}/2$   | $V_{CC}/2$            | $V_{CC}/2$                                    | 0.3       |
| 4.5 to 5.5   | $V_{CC}/2$   | $V_{CC}/2$            | $V_{CC}/2$                                    | 0.3       |

# NL17SZ07

## DEVICE ORDERING INFORMATION

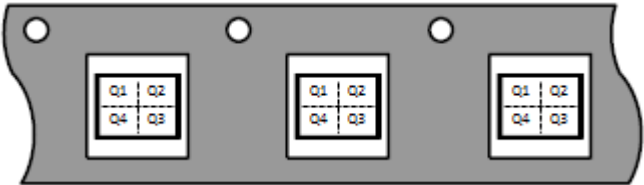
| Device           | Packages                | Specific Device Code   | Pin 1 Orientation<br>(See below) | Shipping <sup>†</sup> |
|------------------|-------------------------|------------------------|----------------------------------|-----------------------|
| NL17SZ07DFT2G    | SC-88A                  | L7                     | Q4                               | 3000 / Tape & Reel    |
| NL17SZ07DFT2G-Q* | SC-88A                  | L7                     | Q4                               | 3000 / Tape & Reel    |
| NL17SZ07DBVT1G   | SC-74A                  | AG                     | Q4                               | 3000 / Tape & Reel    |
| NL17SZ07XV5T2G   | SOT-553                 | L7                     | Q4                               | 4000 / Tape & Reel    |
| NL17SZ07P5T5G    | SOT-953                 | D<br>(Rotated 180° CW) | Q2                               | 8000 / Tape & Reel    |
| NL17SZ07MU3TCG   | UDFN6, 1.0 x 1.0, 0.35P | GR                     | Q4                               | 3000 / Tape & Reel    |

† For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, [BRD8011/D](#).

\* -Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

## Pin 1 Orientation in Tape and Reel

Direction of Feed



PACKAGE DIMENSIONS

## REVISION HISTORY

| Revision | Description of Changes                            | Date      |
|----------|---------------------------------------------------|-----------|
| 24       | Removed one UDFN6 package ordering option and OPN | 1/21/2026 |

\* Please note that this document has been previously updated prior to the inclusion of this revision history table and that the changes tracked only reflect what has occurred on the noted approval dates.


**SC-74A-5 3.00x1.50x0.95, 0.95P**  
**CASE 318BQ**  
**ISSUE C**

DATE 26 FEB 2024


DETAIL "A"  
SCALE 2:1

**GENERIC**  
**MARKING DIAGRAM\***


XXX = Specific Device Code  
M = Date Code  
▪ = Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

## NOTES:

1. DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5-2018.
2. ALL DIMENSION ARE IN MILLIMETERS (ANGLES IN DEGREES).
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OF GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE.

| DIM | MILLIMETERS |      |      |
|-----|-------------|------|------|
|     | MIN.        | NOM. | MAX. |
| A   | 0.90        | 1.00 | 1.10 |
| A1  | 0.01        | 0.18 | 0.10 |
| A2  | 0.95 REF.   |      |      |
| b   | 0.25        | 0.37 | 0.50 |
| c   | 0.10        | 0.18 | 0.26 |
| D   | 2.85        | 3.00 | 3.15 |
| E   | 2.75 BSC    |      |      |
| E1  | 1.35        | 1.50 | 1.65 |
| e   | 0.95 BSC    |      |      |
| L   | 0.20        | 0.40 | 0.60 |
| L1  | 0.62 REF.   |      |      |
| L2  | 0.25 BSC    |      |      |
| θ   | 0°          | 5°   | 10°  |



## RECOMMENDED MOUNTING FOOTPRINT\*

\* FOR ADDITIONAL INFORMATION ON OUR Pb-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

|                         |                                       |                                                                                                                                                                                  |
|-------------------------|---------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>DOCUMENT NUMBER:</b> | <b>98AON66279G</b>                    | Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. |
| <b>DESCRIPTION:</b>     | <b>SC-74A-5 3.00x1.50x0.95, 0.95P</b> | <b>PAGE 1 OF 1</b>                                                                                                                                                               |

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SCALE 2:1

SC-88A (SC-70-5/SOT-353)  
CASE 419A-02  
ISSUE M

DATE 11 APR 2023



RECOMMENDED  
MOUNTING FOOTPRINT

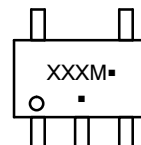
\* For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETERS
3. 419A-01 OBSOLETE. NEW STANDARD 419A-02
4. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.1016MM PER SIDE.

| DIM | MILLIMETERS |      |      |
|-----|-------------|------|------|
|     | MIN.        | NOM. | MAX. |
| A   | 0.80        | 0.95 | 1.10 |
| A1  | ---         | ---  | 0.10 |
| A3  | 0.20 REF    |      |      |
| b   | 0.10        | 0.20 | 0.30 |
| c   | 0.10        | ---  | 0.25 |
| D   | 1.80        | 2.00 | 2.20 |
| E   | 2.00        | 2.10 | 2.20 |
| E1  | 1.15        | 1.25 | 1.35 |
| e   | 0.65 BSC    |      |      |
| L   | 0.10        | 0.15 | 0.30 |

GENERIC MARKING  
DIAGRAM\*



\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

XXX = Specific Device Code

M = Date Code

▪ = Pb-Free Package

(Note: Microdot may be in either location)

STYLE 1:

- PIN 1. BASE
2. EMITTER
3. BASE
4. COLLECTOR
5. COLLECTOR

STYLE 2:

- PIN 1. ANODE
2. EMITTER
3. BASE
4. COLLECTOR
5. CATHODE

STYLE 3:

- PIN 1. ANODE 1
2. N/C
3. ANODE 2
4. CATHODE 2
5. CATHODE 1

STYLE 4:

- PIN 1. SOURCE 1
2. DRAIN 1/2
3. SOURCE 1
4. GATE 1
5. GATE 2

STYLE 5:

- PIN 1. CATHODE
2. COMMON ANODE
3. CATHODE 2
4. CATHODE 3
5. CATHODE 4

STYLE 6:

- PIN 1. EMITTER 2
2. BASE 2
3. EMITTER 1
4. COLLECTOR
5. COLLECTOR 2/BASE 1

STYLE 7:

- PIN 1. BASE
2. EMITTER
3. BASE
4. COLLECTOR
5. COLLECTOR

STYLE 8:

- PIN 1. CATHODE
2. COLLECTOR
3. N/C
4. BASE
5. EMITTER

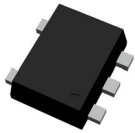
STYLE 9:

- PIN 1. ANODE
2. CATHODE
3. ANODE
4. ANODE
5. ANODE

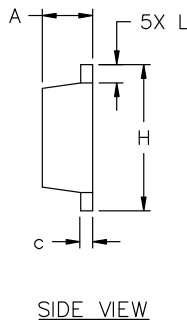
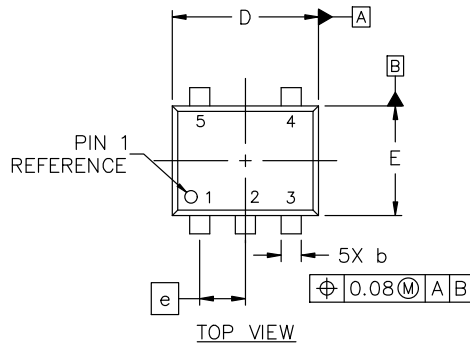
Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

|                  |                          |                                                                                                                                                                                  |
|------------------|--------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
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| DESCRIPTION:     | SC-88A (SC-70-5/SOT-353) | PAGE 1 OF 1                                                                                                                                                                      |

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**SOT-553-5 1.60x1.20x0.55, 0.50P**  
**CASE 463B**  
**ISSUE D**

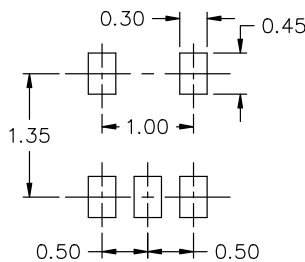
DATE 21 FEB 2024



## NOTES:

1. DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5-2018.
2. ALL DIMENSION ARE IN MILLIMETERS.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

| DIM | MILLIMETERS |      |      |
|-----|-------------|------|------|
|     | MIN.        | NOM. | MAX. |
| A   | 0.50        | 0.55 | 0.60 |
| b   | 0.17        | 0.22 | 0.27 |
| c   | 0.08        | 0.13 | 0.18 |
| D   | 1.55        | 1.60 | 1.65 |
| E   | 1.15        | 1.20 | 1.25 |
| e   | 0.50 BSC    |      |      |
| H   | 1.55        | 1.60 | 1.65 |
| L   | 0.10        | 0.20 | 0.30 |



## RECOMMENDED MOUNTING FOOTPRINT\*

- \* FOR ADDITIONAL INFORMATION ON OUR Pb-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERM/D.

**GENERIC MARKING DIAGRAM\***


XX = Specific Device Code  
M = Date Code  
▪ = Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

STYLE 1:  
PIN 1. BASE  
2. EMITTER  
3. BASE  
4. COLLECTOR  
5. COLLECTOR

STYLE 2:  
PIN 1. CATHODE  
2. COMMON ANODE  
3. CATHODE 2  
4. CATHODE 3  
5. CATHODE 4

STYLE 3:  
PIN 1. ANODE 1  
2. N/C  
3. ANODE 2  
4. CATHODE 2  
5. CATHODE 1

STYLE 4:  
PIN 1. SOURCE 1  
2. DRAIN 1/2  
3. SOURCE 1  
4. GATE 1  
5. GATE 2

STYLE 5:  
PIN 1. ANODE  
2. EMITTER  
3. BASE  
4. COLLECTOR  
5. CATHODE

STYLE 6:  
PIN 1. EMITTER 2  
2. BASE 2  
3. EMITTER 1  
4. COLLECTOR 1  
5. COLLECTOR 2/BASE 1

STYLE 7:  
PIN 1. BASE  
2. EMITTER  
3. BASE  
4. COLLECTOR  
5. COLLECTOR

STYLE 8:  
PIN 1. CATHODE  
2. COLLECTOR  
3. N/C  
4. BASE  
5. EMITTER

STYLE 9:  
PIN 1. ANODE  
2. CATHODE  
3. ANODE  
4. ANODE  
5. ANODE

|                         |                                        |                                                                                                                                                                                  |
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| <b>DESCRIPTION:</b>     | <b>SOT-553-5 1.60x1.20x0.55, 0.50P</b> | <b>PAGE 1 OF 1</b>                                                                                                                                                               |

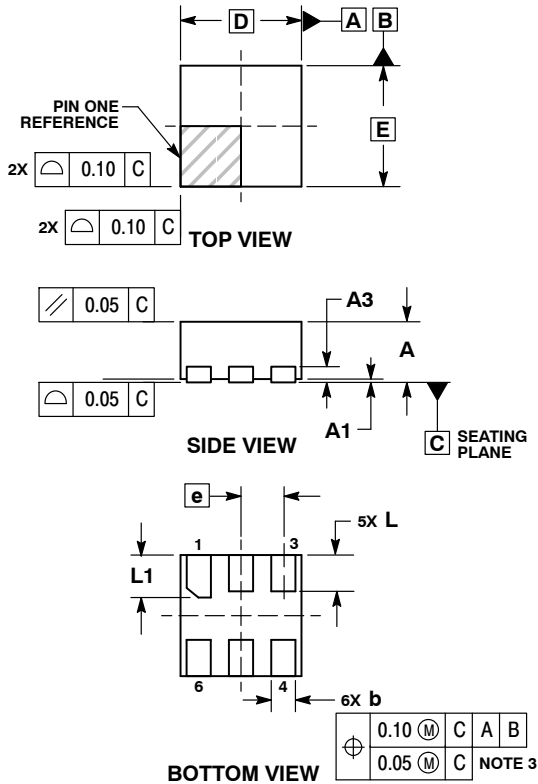
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SCALE 4:1

UDFN6, 1x1, 0.35P  
CASE 517BX  
ISSUE O

DATE 18 MAY 2011

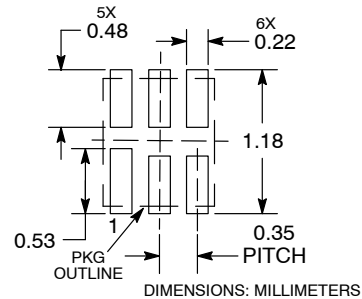


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.20 MM FROM TERMINAL TIP.
4. PACKAGE DIMENSIONS EXCLUSIVE OF BURRS AND MOLD FLASH.

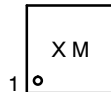
| DIM | MILLIMETERS |      |
|-----|-------------|------|
|     | MIN         | MAX  |
| A   | 0.45        | 0.55 |
| A1  | 0.00        | 0.05 |
| A3  | 0.13        | REF  |
| b   | 0.12        | 0.22 |
| D   | 1.00        | BSC  |
| E   | 1.00        | BSC  |
| e   | 0.35        | BSC  |
| L   | 0.25        | 0.35 |
| L1  | 0.30        | 0.40 |

RECOMMENDED  
SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC  
MARKING DIAGRAM\*

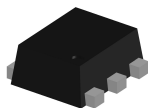


X = Specific Device Code  
M = Date Code

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

|                  |                   |                                                                                                                                                                                     |
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| DESCRIPTION:     | UDFN6, 1x1, 0.35P | PAGE 1 OF 1                                                                                                                                                                         |

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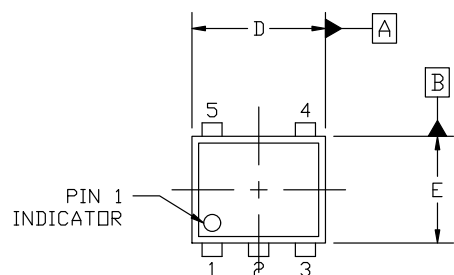


**SOT-953 1.00x0.80x0.37, 0.35P**  
**CASE 527AE**  
**ISSUE F**

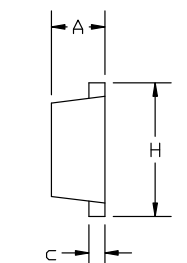
DATE 17 JAN 2024

**NOTES:**

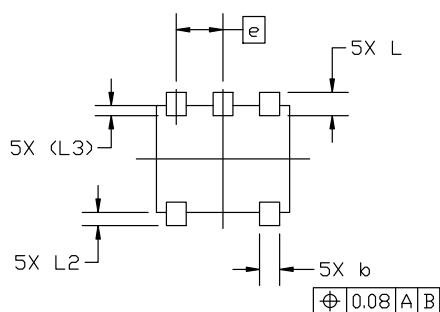
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.



TOP VIEW

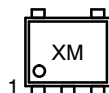


SIDE VIEW



BOTTOM VIEW

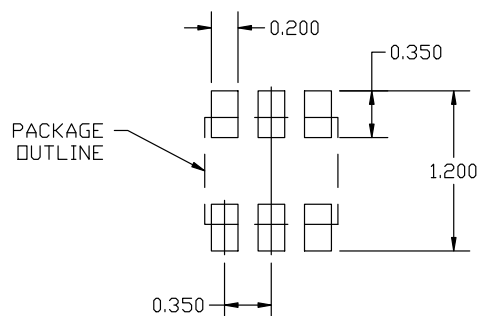
**GENERIC  
MARKING DIAGRAM\***



X = Specific Device Code  
M = Month Code

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

| MILLIMETERS |             |       |       |
|-------------|-------------|-------|-------|
| DIM         | MIN         | NOM   | MAX   |
| A           | 0.34        | 0.37  | 0.40  |
| b           | 0.10        | 0.15  | 0.20  |
| C           | 0.07        | 0.12  | 0.17  |
| D           | 0.95        | 1.00  | 1.05  |
| E           | 0.75        | 0.80  | 0.85  |
| e           | 0.35 BSC    |       |       |
| H           | 0.95        | 1.00  | 1.05  |
| L           | 0.125       | 0.175 | 0.225 |
| L2          | 0.05        | 0.10  | 0.15  |
| L3          | 0.075 (REF) |       |       |



**RECOMMENDED MOUNTING  
FOOTPRINT**

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

|                         |                                      |                                                                                                                                                                                  |
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| <b>DESCRIPTION:</b>     | <b>SOT-953 1.00x0.80x0.37, 0.35P</b> | <b>PAGE 1 OF 1</b>                                                                                                                                                               |

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